

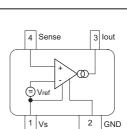
Active Bias Controller

Characteristics

- Supplies stable bias current from 1.8V operating voltage on
- Low voltage drop:
 110mV for 10mA collector currrent

Application notes

- Stabilizing bias current of NPN transistors and FET's from 100µA to 20mA
- Ideal supplement for Sieget and other transistors



- Pb-free (RoHS compliant) package 1)
- Qualified according AEC Q101





Type	Marking	Pin Configuration				Package
BCR410W	W8s	1= Vs	2=GND	3=lout	4=Sense	SOT343

Maximum Ratings

Parameter	Symbol	Value	Unit
Supply voltage	V _S	18	V
Output current	l _{out}	0.5	mA
Total power dissipation, T_S = 110 °C	P _{tot}	100	mW
Junction temperature	$T_{\rm j}$	150	°C
Storage temperature	$T_{ m stq}$	-65 150	

Thermal Resistance

		•	
Junction - soldering point ²⁾	R _{thJS}	≤ 470	K/W

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¹Pb-containing package may be available upon special request

 $^{^{2}}$ For calculation of R_{thJA} please refer to Application Note Thermal Resistance



Electrical Characteristics at $T_A = 25$ °C, unless otherwise specified

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC Characteristics	•	•	•	•	•
Additional current consumption	10	-	200	400	μA
V _S = 3 V					
DC Characteristics with stabilized NPN	N-Transistors	•	•	•	•
Lowest sufficient battery voltage	V _{Smin}	-	1.8	_	V
Voltage drop	$V_{ m drop}$	-	110	-	mV
$I_{\rm C}$ = 10 mA					
Change of I _C versus h _{FE}	$\Delta I_{\rm C}/I_{\rm C}$	-	tbd	-	Δh _{FE} /
$h_{\sf FE} = 50$					h _{FE}
Change of $I_{\mathbb{C}}$ versus $V_{\mathbb{S}}$	$\Delta I_{\rm C}/I_{\rm C}$	-	2	-	%/V
V _S = 3 V					
Change of $I_{\mathbb{C}}$ versus $T_{\mathbb{A}}$	$\Delta I_{\rm C}/I_{\rm C}$	-	0.15	-	%/K

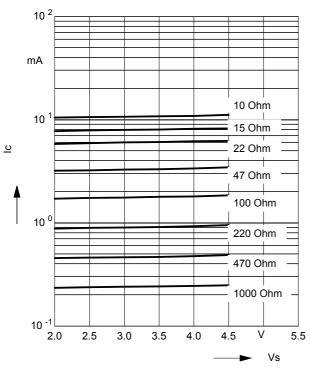
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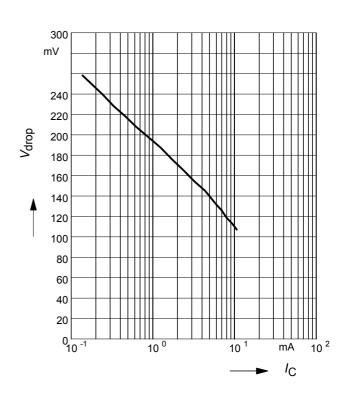
Collector Current $I_C = f(V_S)$

of stabilized NPN Transistor

Parameter $R_{\text{ext.}}(\Omega)$

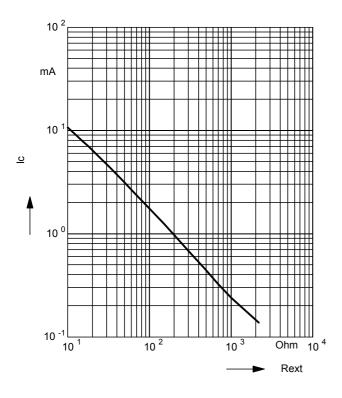


Voltage drop $V_{\text{drop}} = f(I_{\text{C}})$

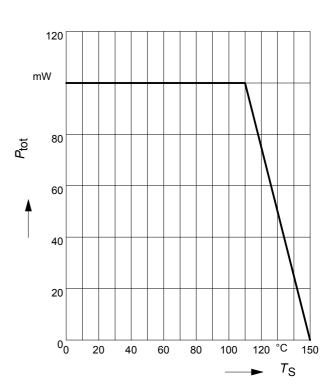


Collector current $I_C = f(R_{ext.})$

of stabilized NPN Transistor

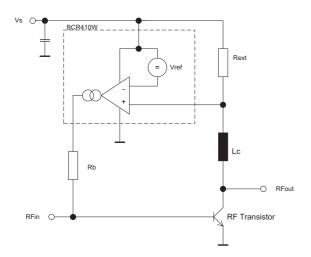


Total power dissipation $P_{tot} = f(T_S)$





Application Circuit:

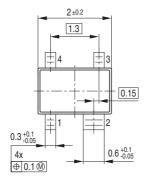


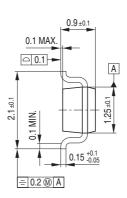
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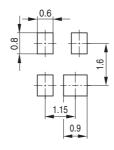
Package Outline



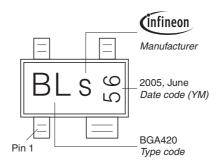




Foot Print

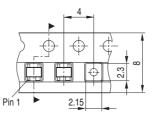


Marking Layout (Example)



Standard Packing

Reel ø180 mm = 3.000 Pieces/Reel Reel ø330 mm = 10.000 Pieces/Reel







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